

SANYO Semiconductors **DATA SHEET**



Static Drive, 1/2-Duty Drive General-Purpose LCD Display Driver

Overview

The LC75841PE is static drive or 1/2-duty drive, microcontroller-controlled general-purpose LCD driver that can be used in applications such as frequency display in products with electronic tuning. In addition to being capable to drive up to 54 segments directly, it can control up to 4 general-purpose output ports.

Features

- Serial data control of switching between static drive mode and 1/2 duty drive mode.
 - When 1/1-duty: Capable of driving up to 27 segments
 - When 1/2-duty: Capable of driving up to 54 segments
- Serial data input supports CCB format communication with the system controller.
- Serial data control of the power-saving mode based backup function and the all segments forced off function.
- Serial data control of switching between the segment output port and general-purpose output port functions (up to 4 general-purpose output ports).
- Serial data control of the frame frequency of the common and segment output waveforms.
- Either RC oscillator operating or external clock operating mode can be selected with the serial control data.
- High generality, since display data is displayed directly without the intervention of a decoder circuit.
- The INH pin allows the display to be forced to the off state.
- Allows compatible operation with the LC75842 (842 mode transfer function).
 - CCB is a registered trademark of SANYO Semiconductor Co., Ltd.
 - CCB is SANYO Semiconductor's original bus format. All bus addresses are managed by SANYO Semiconductor for this format.
 - Any and all SANYO Semiconductor Co.,Ltd. products described or contained herein are, with regard to "standard application", intended for the use as general electronics equipment (home appliances, AV equipment, communication device, office equipment, industrial equipment etc.). The products mentioned herein shall not be intended for use for any "special application" (medical equipment whose purpose is to sustain life, aerospace instrument, nuclear control device, burning appliances, transportation machine, traffic signal system, safety equipment etc.) that shall require extremely high level of reliability and can directly threaten human lives in case of failure or malfunction of the product or may cause harm to human bodies, nor shall they grant any guarantee thereof. If you should intend to use our products for applications outside the standard applications of our customer who is considering such use and/or outside the scope of our intended standard applications, please consult with us prior to the intended use. If there is no consultation or inquiry before the intended use, our customer shall be solely responsible for the use.
 - Specifications of any and all SANYO Semiconductor Co.,Ltd. products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.

Specifications

Absolute Maximum Ratings at $Ta=25^{\circ}C,\,V_{SS}=0V$

| Parameter | Symbol | Conditions | Ratings | Unit | |
|-----------------------------|---------------------|--------------------------------------|------------------------------|------|--|
| Maximum supply voltage | V _{DD} max | V _{DD} | -0.3 to +7.0 | V | |
| Input voltage | V _{IN} 1 | CE, CL, DI, INH | -0.3 to +7.0 | | |
| | V _{IN} 2 | OSC | -0.3 to V _{DD} +0.3 | V | |
| Output voltage | V _{OUT} | S1 to S27, COM1, COM2, P1 to P4, OSC | -0.3 to V _{DD} +0.3 | V | |
| Output current | I _{OUT} 1 | S1 to S27 | 300 | μΑ | |
| | I _{OUT} 2 | COM1, COM2 | 3 | A | |
| | I _{OUT} 3 | P1 to P4 | 5 | mA | |
| Allowable power dissipation | Pd max | Ta=105°C | 50 | mW | |
| Operating temperature | Topr | | -40 to +105 | °C | |
| Storage temperature | Tstg | | -55 to +125 | °C | |

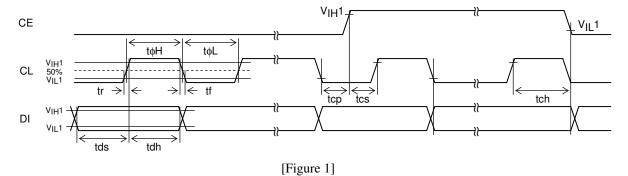
Allowable Operating Ranges at Ta = -40 to +105°C, V_{SS} = 0V

| Parameter | Cumbal | Conditions | | Ratings | | unit |
|---|-------------------|--|---------------------|---------|--------------------|------|
| Parameter | Symbol | Conditions | min | typ | max | |
| Supply voltage | v_{DD} | V_{DD} | 4.0 | | 6.0 | V |
| Input high-level voltage | V _{IH} 1 | CE, CL, DI, INH | 0.45V _{DD} | | 6.0 | V |
| | V _{IH} 2 | OSC External clock operating mode | 0.45V _{DD} | | V_{DD} | V |
| Input low-level voltage | V _{IL} 1 | CE, CL, DI, INH | 0 | | 0.2V _{DD} | |
| | V _{IL} 2 | OSC External clock operating mode | 0 | | 0.2V _{DD} | V |
| Recommended external resistor for RC oscillation | Rosc | OSC RC oscillator operating mode | | 39 | | kΩ |
| Recommended external capacitor for RC oscillation | Cosc | OSC RC oscillator operating mode | | 1000 | | pF |
| Guaranteed range of RC oscillation | fosc | OSC RC oscillator operating mode | 19 | 38 | 76 | kHz |
| External clock operating frequency | fCK | OSC External clock operating mode [Figure 3] | 19 | 38 | 76 | kHz |
| External clock duty cycle | DCK | OSC External clock operating mode [Figure 3] | 30 | 50 | 70 | % |
| Data setup time | tds | CL, DI [Figure 1][Figure 2] | 160 | | | ns |
| Data hold time | tdh | CL, DI [Figure 1][Figure 2] | 160 | | | ns |
| CE wait time | tcp | CE, CL [Figure 1][Figure 2] | 160 | | | ns |
| CE setup time | tcs | CE, CL [Figure 1][Figure 2] | 160 | | | ns |
| CE hold time | tch | CE, CL [Figure 1][Figure 2] | 160 | | | ns |
| High-level clock pulse width | tφH | CL [Figure 1][Figure 2] | 160 | | | ns |
| Low-level clock pulse width | tφL | CL [Figure 1][Figure 2] | 160 | | | ns |
| Rise time | tr | CE, CL, DI [Figure 1][Figure 2] | | 160 | | ns |
| Fall time | tf | CE, CL, DI [Figure 1][Figure 2] | | 160 | | ns |
| INH switching time | tc | NH, CE [Figure 4][Figure 5][Figure 6] | 10 | - | | μs |

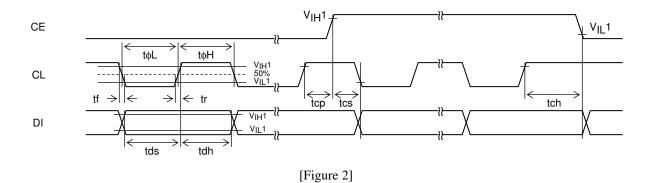
Electrical Characteristics for the Allowable Operating Ranges

| Parameter | Symbol | Pin | Conditions | | Ratings | | unit |
|-----------------------------|-------------------|-----------------|---|----------------------------|---------------------|----------------------------|------|
| raiametei | Syllibol | FIII | Conditions | min | typ | max | unit |
| Hysteresis | ٧ _H | CE, CL, DI, INH | | | 0.03V _{DD} | | V |
| Input high-level current | I _{IH} 1 | CE, CL, DI, INH | V _I =6.0V | | | 5.0 | |
| | I _{IH} 2 | OSC | V _I =V _{DD} External clock operating mode | | | 5.0 | μΑ |
| Input low-level current | I _{IL} 1 | CE, CL, DI, INH | V _I =0V | -5.0 | | | |
| | I _{IL} 2 | OSC | V _I =0V External clock operating mode | -5.0 | | | μΑ |
| Output high-level voltage | V _{OH} 1 | S1 to S27 | Ι _Ο =-20μΑ | V _{DD} -0.9 | | | |
| | V _{OH} 2 | COM1, COM2 | Ι _Ο =-100μΑ | V _{DD} -0.9 | | | ٧ |
| | V _{OH} 3 | P1 to P4 | I _O =-1mA | V _{DD} -0.9 | | | |
| Output low-level voltage | V _{OL} 1 | S1 to S27 | Ι _Ο =20μΑ | | | 0.9 | |
| | V _{OL} 2 | COM1, COM2 | I _O =100μA | | | 0.9 | V |
| | V _{OL} 3 | P1 to P4 | I _O =1mA | | | 0.9 | |
| Output middle-level voltage | V _{MID} | COM1, COM2 | 1/2 bias I _O =±100μA | 1/2V _{DD} -0.9 | | 1/2V _{DD} +0.9 | V |
| Oscillator frequency | fosc | OSC | RC oscillator operating mode, Rosc=39kΩ, Cosc=1000pF | 30.4 | 38 | 45.6 | kHz |
| Current drain | I _{DD} 1 | V _{DD} | Power-saving mode | | | 15 | |
| | I _{DD} 2 | V _{DD} | V _{DD} =6.0V, Output open, RC oscillator operating mode, fosc=38kHz, Static | | 350 | 700 | |
| | I _{DD} 3 | V _{DD} | V _{DD} =6.0V, Output open, RC oscillator operating mode, fosc=38kHz, 1/2 duty | | 1500 | 3000 | |
| | I _{DD} 4 | V _{DD} | V _{DD} =6.0V, Output open, External clock operating mode, f _{CK} =38kHz, V _{IH} 2=0.5V _{DD} , V _{IL} 2=0.1V _{DD} , Static | | 450 | 900 | μА |
| | I _{DD} 5 | V _{DD} | V _{DD} =6.0V, Output open, External clock operating mode, f _{CK} =38kHz, V _{IH} 2=0.5V _{DD} , V _{IL} 2=0.1V _{DD} , 1/2 duty | | 1600 | 3200 | |

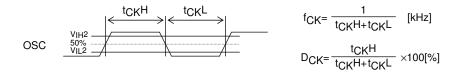
1. When CL is stopped at the low level



2. When CL is stopped at the high level



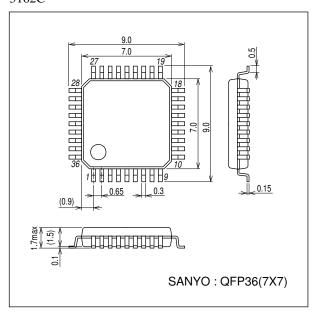
3. OSC pin clock timing in external clock operating mode



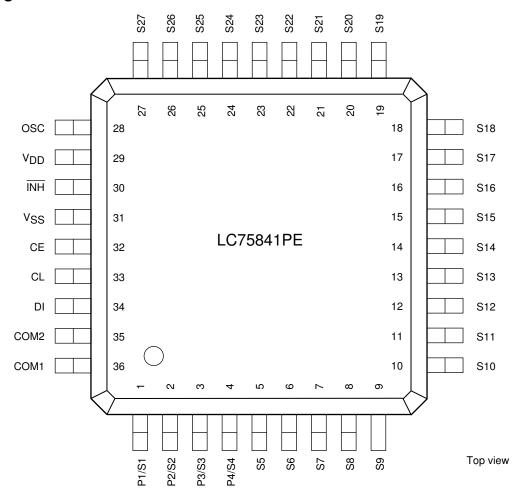
[Figure 3]

Package Dimensions

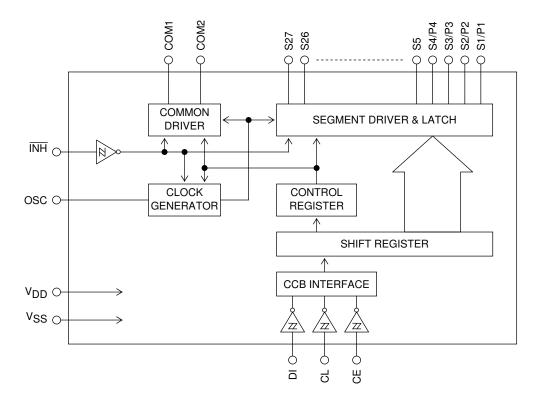
unit:mm (typ) 3162C



Pin Assignment



Block Diagram

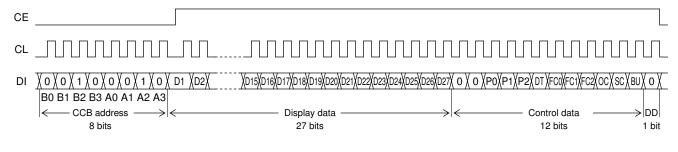


Pin Functions

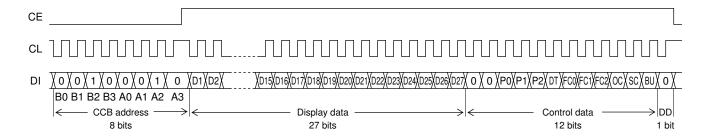
| Symbol | Pin No. | Function | Active | I/O | Handling when unused |
|-----------------------------|-------------------|---|--------|-------------|----------------------------|
| S1/P1 to S4/P4 S5 to S27 | 1 to 4 5 to 27 | Segment outputs for displaying the display data transferred by serial data input. The S1/P1 to S4/P4 pins can be used as general-purpose output ports when so set up by the control data. | - | 0 | OPEN |
| COM1 COM2 | 36 35 | Common driver outputs. The frame frequency is fo [Hz]. | - | 0 | OPEN |
| OSC | 28 | Oscillator connection. An oscillator circuit is formed by connecting an external resistor and capacitor to this pin. This pin can be used as the external clock input pin if external clock operating mode is selected with the control data. | - | I/O | V _{DD} |
| CE CL DI | 32 33 34 | Serial data transfer inputs. Must be connected to the controller. CE: Chip enable CL: Synchronization clock DI: Transfer data | H | 1 1 1 | GND |
| ĪNH | 30 | Display off control input • INH = low (VSS)Display forced off S1/P1 to S4/P4 = low (VSS) (These pins are forcibly set to the segment output port function and held at the VSS level.) S5 to S27 = low (VSS) COM1, COM2 = low (VSS) OSC = Z (high impedance) RC oscillation stopped Inhibits external clock input. • INH = high (VDD)Display on RC oscillation enabled (RC oscillator operating mode) Enables external clock input (external clock operating mode) However, serial data transfer is possible when the display is forced off. | L | ı | GND |
| V _{DD} | 29 | Power supply. Provide a voltage in the range 4.0 to 6.0V. | - | - | - |
| V_{SS} | 31 | Ground pin. Must be connected to ground. | - | - | - |
| | | - | | | |

Serial Data Transfer Formats

- (1) Static drive mode
- 1. When CL is stopped at the low level

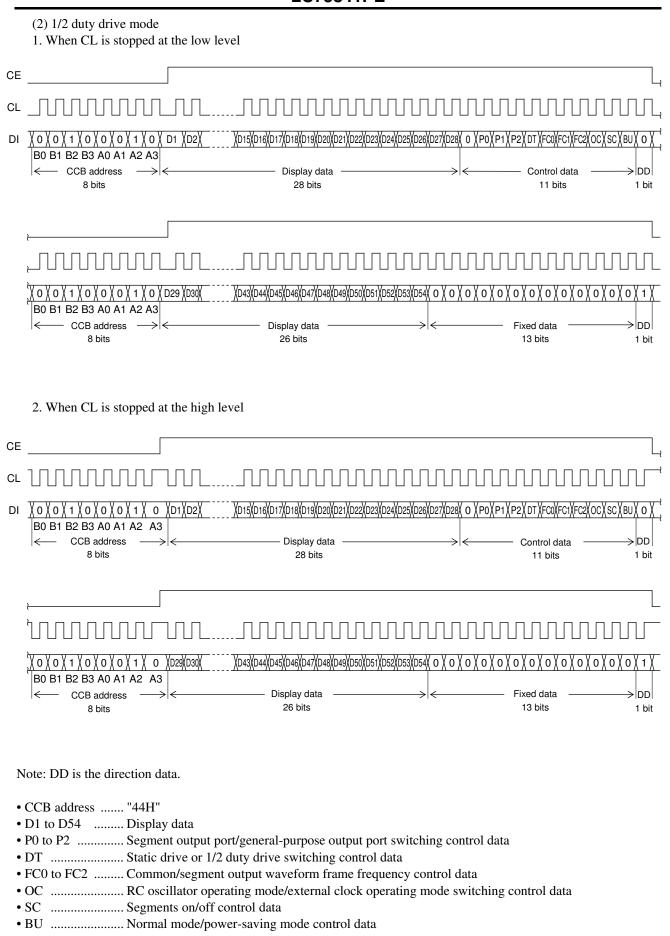


2. When CL is stopped at the high level



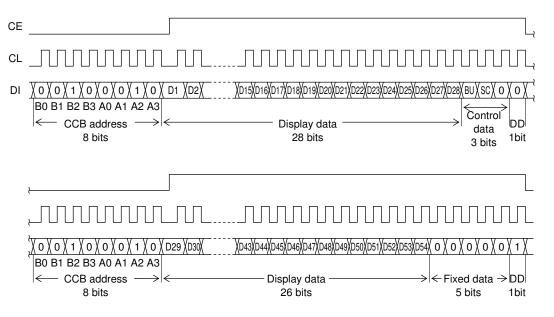
Note: DD is the direction data.

- CCB address "44H"
- D1 to D27 Display data
- P0 to P2 Segment output port/general-purpose output port switching control data
- DT Static drive or 1/2 duty drive switching control data
- FC0 to FC2 Common/segment output waveform frame frequency control data
- SC Segments on/off control data
- BU Normal mode/power-saving mode control data

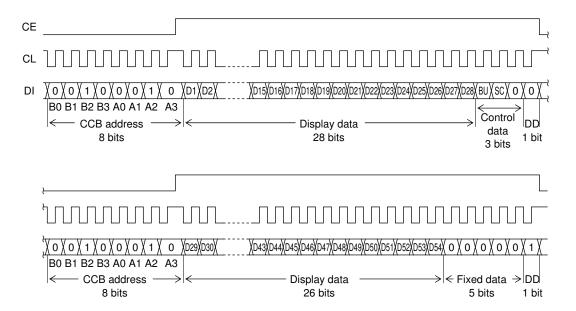


Serial Data Transfer Formats (When in 842 mode data transfer)

- (1) 1/2 duty drive mode (When in 842 mode data transfer)
- 1. When CL is stopped at the low level



2. When CL is stopped at the high level



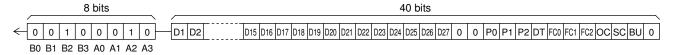
Note: DD is the direction data.

- CCB address "44H"
- D1 to D54 Display data
- BU Normal mode/power-saving mode control data
- SC Segments on/off control data

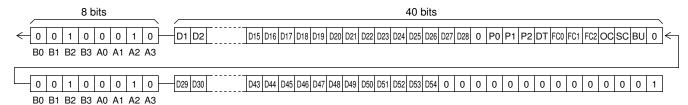
Serial Data Transfer Examples

(1) Static drive mode

The serial data shown in the figure below must be sent.

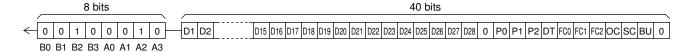


- (2) 1/2 duty drive mode
- When 29 or more segments are used
 96 bits of serial data (including CCB address bits) must be sent.



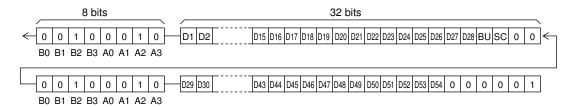
• When fewer than 29 segments are used

The serial data shown below (the D1 to D28 display data and the control data) must always be sent.



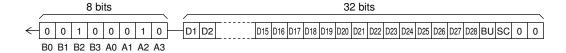
Serial Data Transfer Examples (When in 842 mode data transfer)

- (1) 1/2 duty drive mode (When in 842 mode data transfer)
- When 29 or more segments are used 80 bits of serial data (including CCB address bits) must be sent.



• When fewer than 29 segments are used

The serial data shown in the figure below (the D1 to D28 display data, and the control data) must be sent.



Control Data Functions

P0 to P2: Segment output port/general-purpose output port switching control data
 These control data bits switch the segment output port/general-purpose output port functions of the S1/P1 to S4/P4 output pins.

However, segment output port is forcibly selected when in 842 mode data transfer.

| Control data | | | Output pin state | | | |
|--------------|----|----|------------------|-------|-------|-------|
| P0 | P1 | P2 | S1/P1 | S2/P2 | S3/P3 | S4/P4 |
| 0 | 0 | 0 | S1 | S2 | S3 | S4 |
| 0 | 0 | 1 | P1 | S2 | S3 | S4 |
| 0 | 1 | 0 | P1 | P2 | S3 | S4 |
| 0 | 1 | 1 | P1 | P2 | P3 | S4 |
| 1 | 0 | 0 | P1 | P2 | P3 | P4 |

Note: Sn (n = 1 to 4): Segment output ports

Pn (n = 1 to 4): General-purpose output ports

Note that when the general-purpose output port function is selected, the correspondence between the output pins and the display data will be that shown in the table.

| Output nin | Correspondin | g display data |
|------------|-------------------|---------------------|
| Output pin | Static drive mode | 1/2 duty drive mode |
| S1/P1 | D1 | D1 |
| S2/P2 | D2 | D3 |
| S3/P3 | D3 | D5 |
| S4/P4 | D4 | D7 |

For example, if the general-purpose output port function is selected for the S4/P4 output pin in 1/2 duty drive mode, it will output a high level (V_{DD}) when display data D7 is 1, and a low level (V_{SS}) when D7 is 0.

2. DT: Static drive mode or 1/2 duty drive mode switching control data
This control data bit selects either static drive mode or 1/2 duty drive mode.
However, 1/2 duty drive mode is forcibly selected when in 842 mode data transfer.

| DT | Duty drive mode | Output pin state (COM2) |
|----|---------------------|-------------------------|
| 0 | Static drive mode | V _{SS} level |
| 1 | 1/2 duty drive mode | COM2 |

Note: COM2...Common output

3. FC0 to FC2: Common/segment output waveform frame frequency control data
These control data bits set the frame frequency of the common and segment output waveforms.
However, fo=fosc/384 is forcibly selected when in 842 mode data transfer.

| Control data | | | |
|--------------|-----|-----|--------------------------------|
| FC0 | FC1 | FC2 | Frame frequency fo [Hz] |
| 1 | 1 | 0 | fosc/768, f _{CK} /768 |
| 1 | 1 | 1 | fosc/576, f _{CK} /576 |
| 0 | 0 | 0 | fosc/384, f _{CK} /384 |
| 0 | 0 | 1 | fosc/288, f _{CK} /288 |
| 0 | 1 | 0 | fosc/192, f _{CK} /192 |

4. OC: RC oscillator operating mode/external clock operating mode switching control data

This control data bit switches the OSC pin function

(either RC oscillator operating mode or external clock operating mode).

However RC oscillator operating mode is forcibly selected when in 842 mode data transfer.

| OC | OSC pin function |
|----|-------------------------------|
| 0 | RC oscillator operating mode |
| 1 | External clock operating mode |

Note: An external resistor, Rosc, and an external capacitor, Cosc, must be connected to the OSC pin if RC oscillator operating mode is selected.

5. SC: Segment on/off control data

This control data bit controls the on/off state of the segments.

| SC | Display state |
|----|---------------|
| 0 | On |
| 1 | Off |

Note that when the segments are turned off by setting SC to 1, the segments are turned off by outputting segment off waveforms from the segment output pins.

6. BU: Normal mode/power-saving mode control data

This control data bit selects either normal mode or power-saving mode.

| BU | Mode |
|----|--|
| 0 | Normal mode |
| 1 | Power-saving mode. In RC oscillator operating mode (OC = 0), the OSC pin oscillator is stopped, and in external clock operating mode (OC = 1), acceptance of the external clock is stopped. In this mode the common and segment output pins go to the VSS levels. However, S1/P1 to S4/P4 output pins that are set to be general-purpose output ports by the control data P0 to P2 can be used as general-purpose output ports. |

Display Data and Output Pin Correspondence

(1) Static drive mode

| (1) Static drive mode | | | | |
|-----------------------|------|--|--|--|
| Output pin | COM1 | | | |
| S1/P1 | D1 | | | |
| S2/P2 | D2 | | | |
| S3/P3 | D3 | | | |
| S4/P4 | D4 | | | |
| S5 | D5 | | | |
| S6 | D6 | | | |
| S 7 | D7 | | | |
| S8 | D8 | | | |
| S9 | D9 | | | |
| S10 | D10 | | | |

| Output pin | COM1 | |
|------------|------|--|
| S11 | D11 | |
| S12 | D12 | |
| S13 | D13 | |
| S14 | D14 | |
| S15 | D15 | |
| S16 | D16 | |
| S17 | D17 | |
| S18 | D18 | |
| S19 | D19 | |
| S20 | D20 | |
| | | |

| | _ |
|------------|------|
| Output pin | COM1 |
| S21 | D21 |
| S22 | D22 |
| S23 | D23 |
| S24 | D24 |
| S25 | D25 |
| S26 | D26 |
| S27 | D27 |
| | |

Notes: This applies to the case where the S1/P1 to S4/P4 output pins are set to be segment output ports.

The static drive mode cannot be selected when in 842 mode data transfer.

For example, the table below lists the output states for the S11 output pin.

| Display data | Output pin (S11) state | |
|--------------|--|--|
| D11 | | |
| 0 | The LCD segment corresponding to COM1 is off | |
| 1 | The LCD segment corresponding to COM1 is on | |

(2) 1/2 duty drive mode

| Output pin | COM1 | COM2 |
|------------|------|------|
| S1/P1 | D1 | D2 |
| S2/P2 | D3 | D4 |
| S3/P3 | D5 | D6 |
| S4/P4 | D7 | D8 |
| S5 | D9 | D10 |
| S6 | D11 | D12 |
| S7 | D13 | D14 |
| S8 | D15 | D16 |
| S9 | D17 | D18 |
| S10 | D19 | D20 |

| Output pin | COM1 | COM2 | |
|------------|------|------|--|
| S11 | D21 | D22 | |
| S12 | D23 | D24 | |
| S13 | D25 | D26 | |
| S14 | D27 | D28 | |
| S15 | D29 | D30 | |
| S16 | D31 | D32 | |
| S17 | D33 | D34 | |
| S18 | D35 | D36 | |
| S19 | D37 | D38 | |
| S20 | D39 | D40 | |

| Output pin | COM1 | COM2 | |
|------------|------|------|--|
| S21 | D41 | D42 | |
| S22 | D43 | D44 | |
| S23 | D45 | D46 | |
| S24 | D47 | D48 | |
| S25 | D49 | D50 | |
| S26 | D51 | D52 | |
| S27 | D53 | D54 | |

Note: This applies to the case where the S1/P1 to S4/P4 output pins are set to be segment output ports.

For example, the table below lists the output states for the S11 output pin.

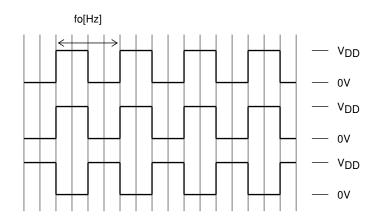
| To to example, the table below lists the output states for the STT output pin. | | | |
|--|--------------|--|--|
| Displa | Display data | | |
| D21 | D22 | Output pin (S11) state | |
| 0 | 0 | The LCD segments corresponding to COM1 and COM2 are off. | |
| 0 | 1 | The LCD segment corresponding to COM2 is on. | |
| 1 | 0 | The LCD segment corresponding to COM1 is on. | |
| 1 | 1 | The LCD segments corresponding to COM1 and COM2 are on. | |

Output Waveforms (Static drive mode)

COM₁

LCD driver output when off

LCD driver output when on



Output Waveforms (1/2 duty, 1/2 bias drive mode)

COM1

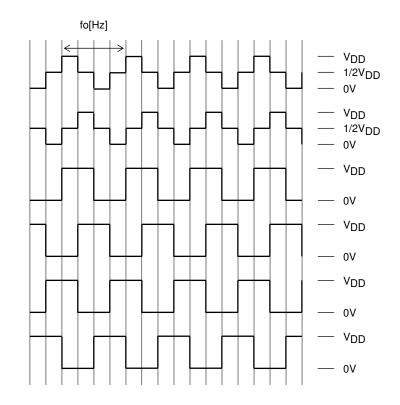
COM₂

LCD driver output when all LCD segments corresponding to COM1 and COM2 are off.

LCD driver output when only LCD segments corresponding to COM1 are on.

LCD driver output when only LCD segments corresponding to COM2 are on.

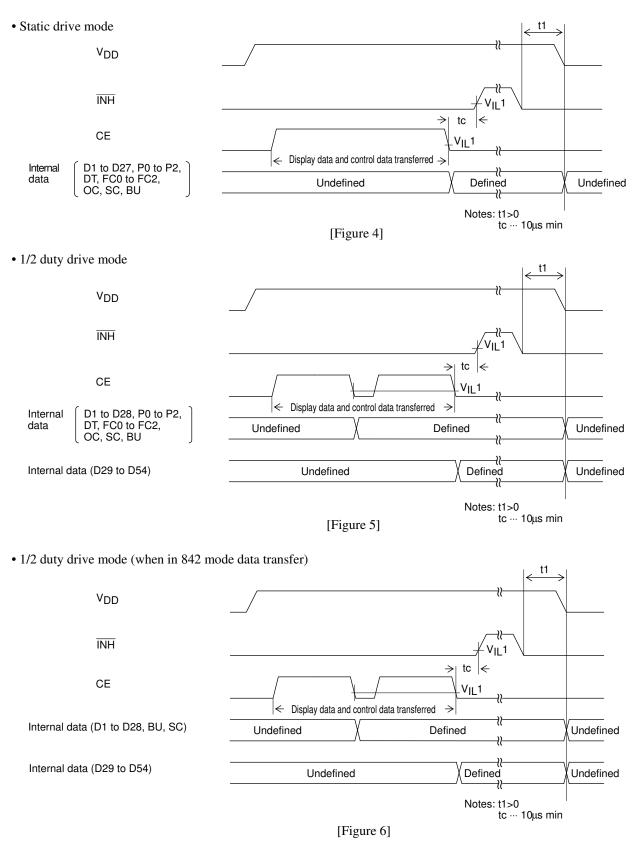
LCD driver output when all LCD segments corresponding to COM1 and COM2 are on.



| | Control data | | |
|-----|--------------|-----|--------------------------------|
| FC0 | FC1 | FC2 | Frame frequency fo [Hz] |
| 1 | 1 | 0 | fosc/768, f _{CK} /768 |
| 1 | 1 | 1 | fosc/576, f _{CK} /576 |
| 0 | 0 | 0 | fosc/384, f _{CK} /384 |
| 0 | 0 | 1 | fosc/288, f _{CK} /288 |
| 0 | 1 | 0 | fosc/192, f _{CK} /192 |

Display Control and the INH Pin

Since the IC's internal data (the display data D1 to D27 and the control data when in static drive mode, and the display data D1 to D54 and the control data when in 1/2 duty drive mode) is undefined when power is first applied, applications should set the $\overline{\text{INH}}$ pin low at the same time as power is applied to turn off the display (setting S1/P1 to S4/P4 and S5 to S27, COM1, and COM2 to the VSS level) and during this period send serial data from the controller. The controller should then set the $\overline{\text{INH}}$ pin high after the data transfer has completed. This procedure prevents unnecessary display at power on. (See figure 4, figure 5 and figure 6)



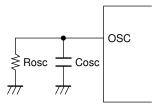
Notes on Controller Transfer of Display Data

Since the LC75841PE transfer the display data (D1 to D54) in two separate transfer operations in 1/2 duty drive mode, we recommend that applications make a point of completing all of the display data transfer within a period of less than 30ms to prevent observable degradation of display quality.

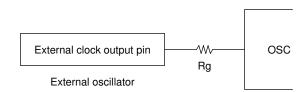
OSC Pin Peripheral Circuit

(1) RC oscillator operating mode (control data OC = 0)

An external resistor, Rosc, and an external capacitor, Cosc, must be connected between the OSC pin and GND if RC oscillator operating mode is selected.



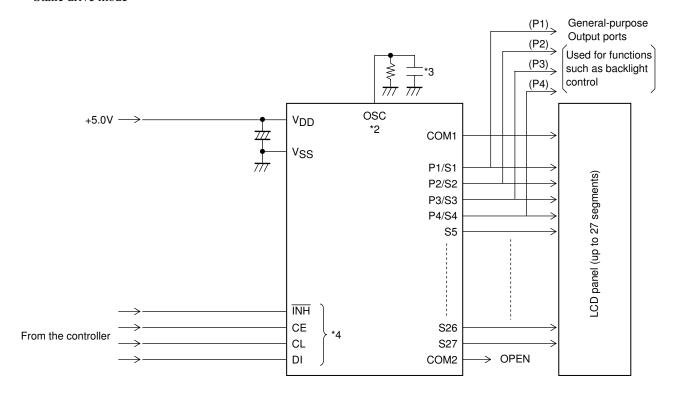
(2) External clock operating mode (control data OC = 1) When the external clock operating mode is selected, insert a current protection resistor Rg (4.7 to $47k\Omega$) between the OSC pin and external clock output pin (external oscillator). Determine the value of the resistance according to the allowable current value at the external clock output pin. Also make sure that the waveform of the external clock is not heavily distorted.



Note: Allowable current value at external clock output pin > $\frac{V_{DD}}{Rg}$

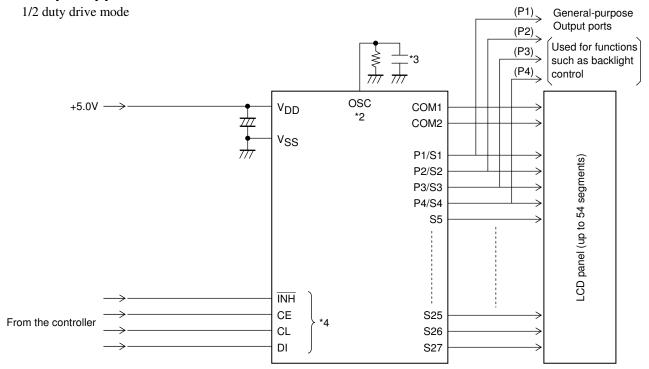
Sample Application Circuit 1

Static drive mode



- *2: In RC oscillator operating mode, an external resistor, Rosc, and an external capacitor, Cosc, must be connected between the OSC pin and ground. If external clock operating mode is selected, a current protection resistor, Rg (4.7 to $47k\Omega$), must be inserted between the external clock output pin (on the external oscillator) and the OSC pin. (See the "OSC Pin Peripheral Circuit" section.)
- *3: When a capacitor except the recommended external capacitance (Cosc = 1000pF) is connected to the OSC pin, it should be in the range 220 to 2200pF.
- *4: The pins to be connected to the controller (CE, CL, DI, INH) can handle 3.3V or 5.0V.

Sample Application Circuit 2



- *2: In RC oscillator operating mode, an external resistor, Rosc, and an external capacitor, Cosc, must be connected between the OSC pin and ground. If external clock operating mode is selected, a current protection resistor, Rg (4.7 to 47kΩ), must be inserted between the external clock output pin (on the external oscillator) and the OSC pin. (See the "OSC Pin Peripheral Circuit" section.)
- *3: When a capacitor except the recommended external capacitance (Cosc = 1000pF) is connected to the OSC pin, it should be in the range 220 to 2200pF.
- *4: The pins to be connected to the controller (CE, CL, DI, INH) can handle 3.3V or 5.0V.
 - SANYO Semiconductor Co.,Ltd. assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all SANYO Semiconductor Co.,Ltd. products described or contained herein.
 - SANYO Semiconductor Co.,Ltd. strives to supply high-quality high-reliability products, however, any and all semiconductor products fail or malfunction with some probability. It is possible that these probabilistic failures or malfunction could give rise to accidents or events that could endanger human lives, trouble that could give rise to smoke or fire, or accidents that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
 - In the event that any or all SANYO Semiconductor Co.,Ltd. products described or contained herein are controlled under any of applicable local export control laws and regulations, such products may require the export license from the authorities concerned in accordance with the above law.
 - No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written consent of SANYO Semiconductor Co.,Ltd.
 - Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the SANYO Semiconductor Co.,Ltd. product that you intend to use.
 - Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production.
 - Upon using the technical information or products described herein, neither warranty nor license shall be granted with regard to intellectual property rights or any other rights of SANYO Semiconductor Co.,Ltd. or any third party. SANYO Semiconductor Co.,Ltd. shall not be liable for any claim or suits with regard to a third party's intellectual property rights which has resulted from the use of the technical information and products mentioned above.

This catalog provides information as of November, 2009. Specifications and information herein are subject to change without notice.